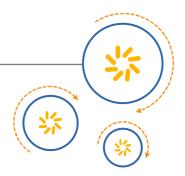


RF360 Europe GmbH
A Qualcomm – TDK Joint Venture



SAW components

SAW filter
Short range devices

Series/type: B3719

Ordering code: B39321B3719H110

Date: July 16, 2017

Version: 2.3

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SAW filter 315.00 MHz

Data sheet

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SAW filter 315.00 MHz

Data sheet

Table of contents

1 Application	4
2 <u>Features</u>	
3 <u>Package</u>	
4 Pin configuration	
5 Matching circuit	
6 Characteristics	
7 Maximum ratings	
8 Transmission coefficient	
9 Packing material	10
10 Marking	12
11 Soldering profile	13
12 ESD protection of SAW filters	14
13 Annotations	15
14 <u>Cautions and warnings</u>	16
Important notes.	

SAW filter 315.00 MHz

Data sheet

1 Application

- Low-loss RF filter for remote control receivers
- \blacksquare No matching network required for operation at 50 Ω

2 Features

- Package size 3.0±0.1 mm × 3.0±0.1 mm
- Package height 1.0±0.115 mm
- Package code DCC6E
- Approximate weight 0.04 g
- RoHS compatible
- Package for Surface Mount Technology (SMT)
- Ni/Au-plated terminals
- Lead free soldering compatible with J-STD20C
- Filter surface passivated
- Electrostatic Sensitive Device (ESD)
- Moisture Sensitivity Level 1 (MSL1)
- AEC-Q200 qualified component family (Grade 1: -40 °C to +125 °C)

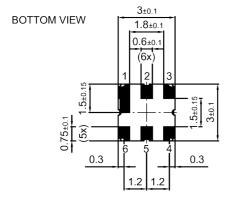


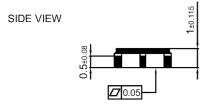
Figure 1: Picture of component with example of product marking.

SAW filter 315.00 MHz

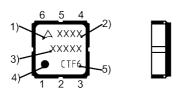
Data sheet

3 Package





TOP VIEW



SIDE VIEW

- 1) Company logo
- 2) Device designation
- 3) Last five digits of the lot number
- 4) Marking for pad number 1
- 5) Example of production location and date code

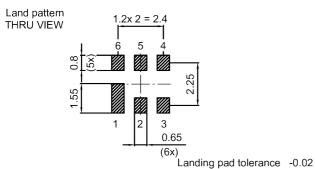


Figure 2: Drawing of package. See Sec. Package information (p. 16).

- 1 Input (recommend or ground)
- 4 Output (recommend or ground)
- 2 Ground (recommend or input)
- 3, 6 Ground
- 5 Ground (recommend or output)



SAW components B3719
SAW filter 315.00 MHz

Data sheet

5 Matching circuit

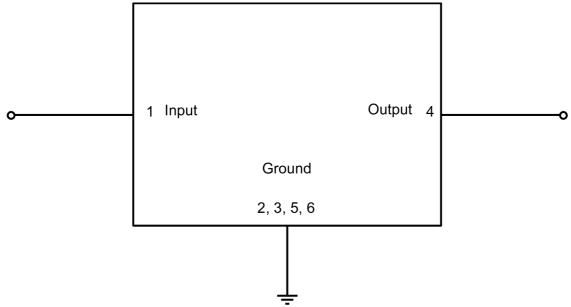


Figure 3: Schematic of matching circuit. No external matching components required.



SAW filter 315.00 MHz

Data sheet

6 Characteristics

Temperature range for specification $T_{\text{SPEC}} = -40 \,^{\circ}\text{C} \dots +85 \,^{\circ}\text{C}$

Input terminating impedance $Z_{\rm IN} = 50~\Omega$ Output terminating impedance $Z_{\rm OUT} = 50~\Omega$

Characteristics				$\begin{array}{c} \text{min.} \\ \text{for } T_{\text{SPEC}} \end{array}$	typ. @ +25 °C	$\begin{array}{c} \text{max.} \\ \text{for } T_{\text{SPEC}} \end{array}$	
Center frequency			f _C	_	315	<u> </u>	MHz
Maximum insertion attenuation			$\boldsymbol{\alpha}_{\text{max}}$				
	314.5 315.5	MHz		_	1.4	2.01)	dB
	314.5 315.5	MHz		_	1.4	1.9	dB
Amplitude ripple (p-p)			Δα				
	314.5 315.5	MHz		_	0.4	1.0 ¹⁾	dB
	314.5 315.5	MHz		_	0.4	1.0	dB
Maximum VSWR			$VSWR_{max}$				
@ input port	314.5 315.5	MHz		_	1.3	1.6 ¹⁾	
	314.5 315.5	MHz		_	1.3	1.6	
@ output port	314.5 315.5	MHz		_	1.3	1.6 ¹⁾	
	314.5 315.5	MHz		<u> </u>	1.3	1.6	
Minimum attenuation			$\boldsymbol{\alpha}_{min}$				
	270 286	MHz		60 ¹⁾	68	_	dB
	270 286	MHz		60	68	<u> </u>	dB
	293 293.9	MHz		56¹)	64	<u> </u>	dB
	293 293.9	MHz		56	64	<u> </u>	dB
	304 304.6	MHz		49 ¹⁾	53	<u> </u>	dB
	304 304.6	MHz		49	53	_	dB
	325.4 326	MHz		291)	33	<u> </u>	dB
	325.4 326	MHz		29	33	_	dB
	336.1 337	MHz		52 ¹⁾	60	_	dB
	336.1 337	MHz		52	60	_	dB
	357.5 358.7	MHz		55 ¹⁾	63	_	dB
	357.5 358.7	MHz		55	63	_	dB

Valid for temperature $T = -40 \,^{\circ}\text{C...} + 105 \,^{\circ}\text{C.}$



SAW components	B3719
SAW filter	315.00 MHz

Data sheet

7 Maximum ratings

Operable temperature	T _{OP} = -45 °C +125 °C	
Storage temperature	T _{STG} ¹⁾ = −45 °C +125 °C	
DC voltage	V _{DC} = 6.0 V	
Source power	P _s = 13 dBm	Source impedance 50 Ω.

Not valid for packaging material. Storage temperature for packaging material is −25 °C to +40 °C.



SAW components B3719
SAW filter 315.00 MHz

Data sheet

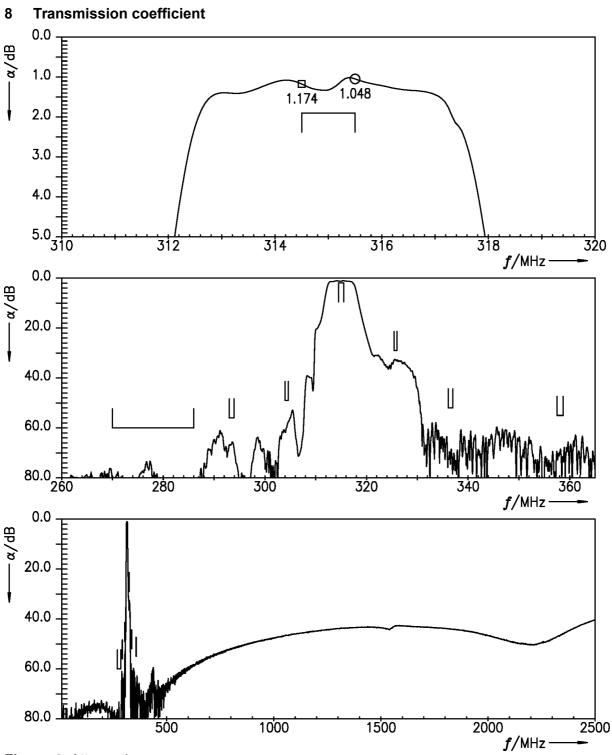


Figure 4: Attenuation.

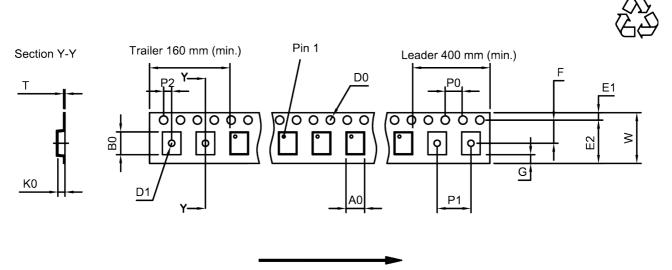


SAW filter 315.00 MHz

Data sheet

9 Packing material

9.1 Tape



User direction of unreeling

Figure 5: Drawing of tape (first-angle projection) with tape dimensions according to Table 1.

A ₀	3.25 _{±0.1} mm	E_2	10.25 mm (min.)	P ₁	4.0±0.1 mm
B_0	3.3±0.1 mm	F	5.5±0.05 mm	P ₂	2.0±0.1 mm
D_0	1.5+0.1/-0 mm	G	0.75 mm (min.)	Т	0.2±0.05 mm
D ₁	1.5 mm (min.)	K_0	1.5±0.1 mm	W	12.0+0.3/-0.1 mm
E ₁	1.75 _{±0.1} mm	P ₀	4.0±0.1 mm		

Table 1: Tape dimensions.



SAW filter 315.00 MHz

Data sheet

9.2 Reel with diameter of 330 mm

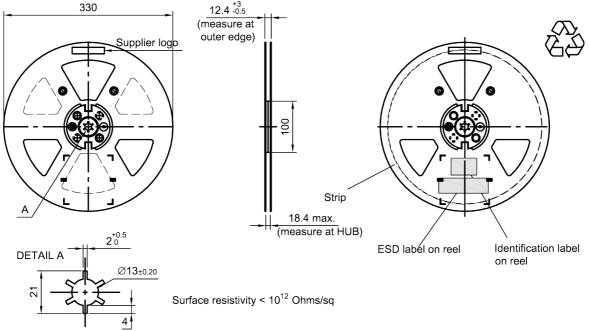
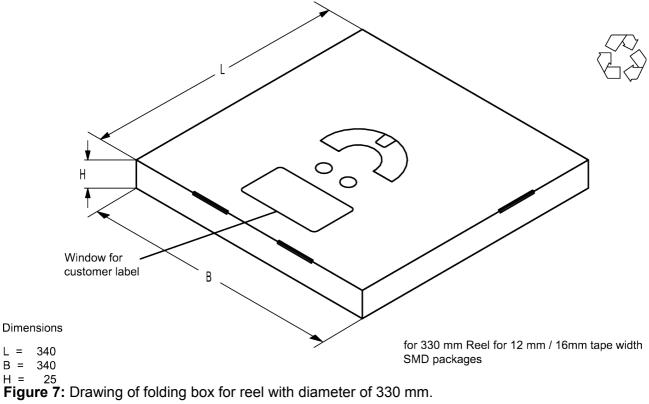


Figure 6: Drawing of reel (first-angle projection) with diameter of 330 mm.





SAW filter 315.00 MHz

Data sheet

10 Marking

Products are marked with device designation, lot number, as well as production location and date code.

■ Device designation: The 4-character device designation of the ordering code is used for the marking.

Example for 4-character device designation: B3xxxxB1234xxxx

■ Lot number: The last 5 digits of the lot number are used for the marking.

Example: <u>12345</u>

■ Production location and date code: The production location is Wuxi (encoded in the first character 'C'). The production date code is encoded in the last three characters according to Table 2.

		1 st digi	t (day)				2 nd digi	t (year)			3 rd digit	(month)	
Day	Code	Day	Code	Day	Code	Year	Code	Year	Code	Month	Code	Month	Code
1	1	11	Α	21	М	2010	Α	2022	Р	Jan	1	Jul	7
2	2	12	В	22	N	2011	В	2023	R	Feb	2	Aug	8
3	3	13	С	23	Р	2012	С	2024	S	Mar	3	Sep	9
4	4	14	D	24	R	2013	D	2025	Т	Apr	4	Oct	0
5	5	15	E	25	S	2014	E	2026	U	May	5	Nov	N
6	6	16	F	26	Т	2015	F	2027	V	Jun	6	Dec	D
7	7	17	Н	27	U	2016	Н	2028	W				
8	8	18	J	28	V	2017	J	2029	Х				
9	9	19	K	29	W	2018	K	2030	Z				
10	0	20	L	30	Х	2019	L	2031	Α				
				31	Z	2020	М	2032	В				
						2021	N	and	so on				

Table 2: Production date code.

Example of how to decode production location and date code:

Code: C T F 6

Location: C \rightarrow Wuxi

Day: T \rightarrow 26th

Year: F \rightarrow 2015

Month: 6 \rightarrow June



SAW components	B3719
SAW filter	315.00 MHz

Data sheet

11 Soldering profile

The recommended soldering process is in accordance with IEC $60068-2-58-3^{rd}$ edit and IPC/JEDEC J-STD-020B.

3 K/s 25 °C to 220 °C, 150 s to 210 s, 0.4 K/s to 1.0 K/s
5 °C to 220 °C, 150 s to 210 s, 0.4 K/s to 1.0 K/s
s to 70 s
n. 10 s
ax. 20 s
60 °C +0/-5 °C
0 °C +5/-0 °C for 10 s ± 1 s
3 K/s
easured at solder pads
3

Table 3: Characteristics of recommended soldering profile for lead-free solder (Sn95.5Ag3.8Cu0.7).

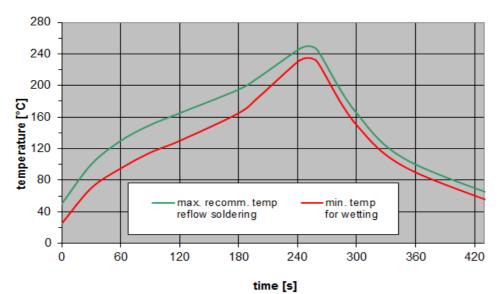


Figure 8: Recommended reflow profile for convection and infrared soldering – lead-free solder.



SAW filter 315.00 MHz

Data sheet

12 ESD protection of SAW filters

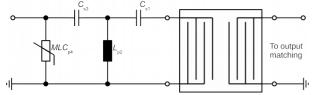
SAW filters are Electro Static Discharge sensitive devices. To reduce the probability of damages caused by ESD, special matching topologies have to be applied.

In general, "ESD matching" has to be ensured at that filter port, where electrostatic discharge is expected.

Electrostatic discharges predominantly appear at the antenna input of RF receivers. Therefore, only the input matching of the SAW filter has to be designed to short circuit or to block the ESD pulse.

Below three figures show recommended "ESD matching" topologies.

For wide band filters the high-pass ESD matching structure needs to be at least of 3rd order to ensure a proper matching for any impedance value of antenna and SAW filter input. The required component values have to be determined from case to case.



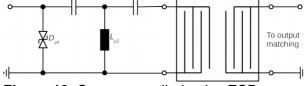


Figure 9: MLC varistor plus ESD matching.

Figure 10: Suppressor diode plus ESD matching.

In cases where minor ESD occur, following simplified "ESD matching" topologies can be used alternatively.

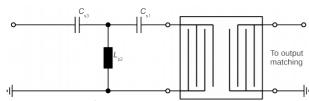


Figure 11: 3rd order high-pass structure for basic ESD protection.

In all three figures the shunt inductor $L_{\rm p2}$ could be replaced by a shorted microstrip with proper length and width. If this configuration is possible depends on the operating frequency and available PCB space.

Effectiveness of the applied ESD protection has to be checked according to relevant industry standards or customer specific requirements.

For further information, please refer to RF360 Application report: "**ESD protection for SAW filters**". This report can be found under www.rf360jv.com/rke. Click on "Applications Notes".



SAW filter 315.00 MHz

Data sheet

13 Annotations

13.1 Matching coils

See TDK inductor pdf-catalog http://www.tdk.co.jp/tefe02/coil.htm#aname1 and Data Library for circuit simulation http://www.tdk.co.jp/etvcl/index.htm.

13.2 RoHS compatibility

ROHS-compatible means that products are compatible with the requirements according to Art. 4 (substance restrictions) of Directive 2011/65/EU of the European Parliament and of the Council of June 8th, 2011, on the restriction of the use of certain hazardous substances in electrical and electronic equipment ("Directive") with due regard to the application of exemptions as per Annex III of the Directive in certain cases.

13.3 Scattering parameters (S-parameters)

The pin/port assignment is available in the headers of the S-parameter files. Please contact your local RF360 sales office.



SAW filter 315.00 MHz

Data sheet

14 Cautions and warnings

14.1 Display of ordering codes for RF360 products

The ordering code for one and the same product can be represented differently in data sheets, data books, other publications and the website of RF360, or in order-related documents such as shipping notes, order confirmations and product labels. The varying representations of the ordering codes are due to different processes employed and do not affect the specifications of the respective products. Detailed information can be found on the Internet under www.rf360jv.com/orderingcodes.

14.2 Material information

Due to technical requirements components may contain dangerous substances. For information on the type in question please also contact one of our sales offices.

For information on recycling of tapes and reels please contact one of our sales offices.

14.3 Moldability

Before using in overmolding environment, please contact your local RF360 sales office.

14.4 Package information

Landing area

The printed circuit board (PCB) land pattern (landing area) shown is based on RF360 internal development and empirical data and illustrated for example purposes, only. As customers' SMD assembly processes may have a plenty of variants and influence factors which are not under control or knowledge of RF360, additional careful process development on customer side is necessary and strongly recommended in order to achieve best soldering results tailored to the particular customer needs.

Dimensions

Unless otherwise specified all dimensions are understood using unit millimeter (mm).

Projection method

Unless otherwise specified first-angle projection is applied.



Important notes

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